BFP840FESD

SiGe:C NPN RF bipolar transistor

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Product description

The BFP840FESD is a discrete RF heterojunction bipolar transistor (HBT) with an integrated ESD protection suitable for 5 GHz band applications.

Feature list

- Unique combination of high end RF performance and robustness: 20 dBm maximum RF input power, 1.5 kV HBM ESD hardness
- High transition frequency f_T = 85 GHz to enable best in class noise performance at high frequencies: NF_{min} = 0.75 dB at 5.5 GHz, 1.8 V, 5 mA
- High gain G_{ms} = 23 dB at 5.5 GHz, 1.8 V, 10 mA
- OIP_3 = 22 dBm at 5.5 GHz, 1.8 V, 10 mA
- Suitable for low voltage applications e.g. V_{CC} = 1.2 V and 1.8 V (2.85 V, 3.3 V, 3.6 V require a corresponding collector resistor)

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

Potential applications

- WLAN, WiMAX and UWB
- Satellite communication systems: satellite radio (SDARs, DAB), navigation systems (e.g. GPS, GLONASS, BeiDou, Galileo)

Device information

Table 1 Part information

Product name / Ordering code	Package	Pin configuration				Marking	Pieces / Reel
BFP840FESD / BFP840FESDH6327XTSA1	TSFP-4-1	1 = B	2 = E	3 = C	4 = E	T8s	3000

***Attention**: ESD (Electrostatic discharge) sensitive device, observe handling precautions*

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1 Absolute maximum ratings

Table 2 Absolute maximum ratings at T_A = 25 °C (unless otherwise specified)

Parameter	Symbol	Values		Unit	Note or test condition
		Min.	Max.		
Collector emitter voltage	V_{CEO}	–	2.25	V	Open base
			2.0		T_A = -55°C, open base
Collector base voltage [1]	V_{CBO}		2.9		Open emitter
			2.6		T_A = -55°C, open emitter
Collector emitter voltage [2]	V_{CES}		2.25		E-B short circuited
			2.0		T_A = -55°C, E-B short circuited
Base current	I_B	-5	3	mA	–
Collector current	I_C	–	35		
RF input power	P_{RFin}	–	20	dBm	
ESD stress pulse	V_{ESD}	-1.5	1.5	kV	HBM, all pins, acc. to JESD22-A114
Total power dissipation [3]	P_{tot}	–	75	mW	$T_S \leq 109$ °C
Junction temperature	T_J	–	150	°C	–
Storage temperature	T_{Stg}	-55			

Attention**: **Stresses above the max. values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Exceeding only one of these values may cause irreversible damage to the integrated circuit.

1 V_{CBO} is similar to V_{CEO} due to design.
2 V_{CES} is similar to V_{CEO} due to design.
3 T_S is the soldering point temperature. T_S is measured on the emitter lead at the soldering point of the PCB.

2 Thermal characteristics

Table 3 Thermal resistance

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Junction - soldering point	R_{thJS}	–	541	–	K/W	–

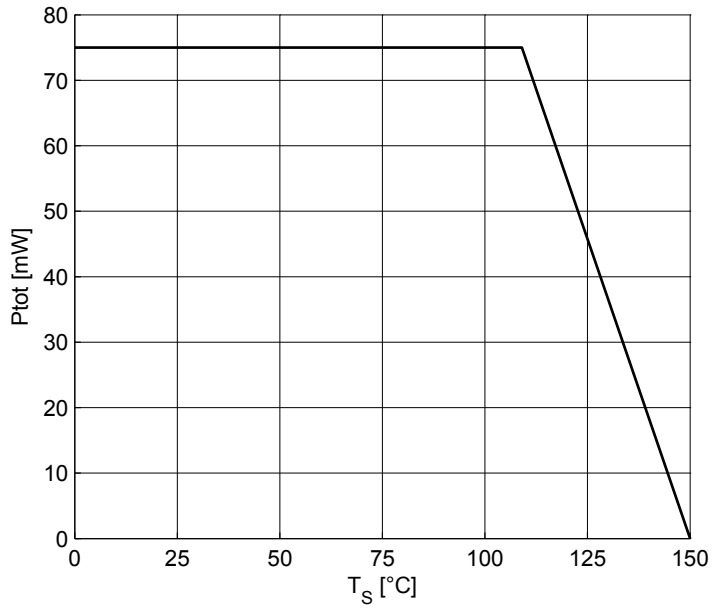

Figure 1 Total power dissipation $P_{tot} = f(T_S)$

3 Electrical characteristics

3.1 DC characteristics

Table 4 **DC characteristics at T_A = 25 °C**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Collector emitter breakdown voltage	$V_{(BR)CEO}$	2.25	2.6	–	V	I_C = 1 mA, I_B = 0, open base
Collector emitter leakage current	I_{CES}	–	–	400 [1]	nA	V_{CE} = 1.5 V, V_{BE} = 0, E-B short circuited
Collector base leakage current	I_{CBO}			400 [1]		V_{CB} = 1.5 V, I_E = 0, open emitter
Emitter base leakage current	I_{EBO}			10 [1]	µA	V_{EB} = 0.5 V, I_C = 0, open collector
DC current gain	h_{FE}	150	260	450		V_{CE} = 1.8 V, I_C = 10 mA, pulse measured

3.2 General AC characteristics

Table 5 **General AC characteristics at T_A = 25 °C**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Transition frequency	f_T	–	85	–	GHz	V_{CE} = 1.8 V, I_C = 25 mA, f = 2 GHz
Collector base capacitance	C_{CB}		38		fF	V_{CB} = 1.8 V, V_{BE} = 0, f = 1 MHz, emitter grounded
Collector emitter capacitance	C_{CE}		0.37		pF	V_{CE} = 1.8 V, V_{BE} = 0, f = 1 MHz, base grounded
Emitter base capacitance	C_{EB}		0.37			V_{EB} = 0.4 V, V_{CB} = 0, f = 1 MHz, collector grounded

1 Maximum values not limited by the device but by the short cycle time of the 100% test

3.3 Frequency dependent AC characteristics

Measurement setup is a test fixture with Bias-T's in a 50 Ω system, T_A = 25 °C.

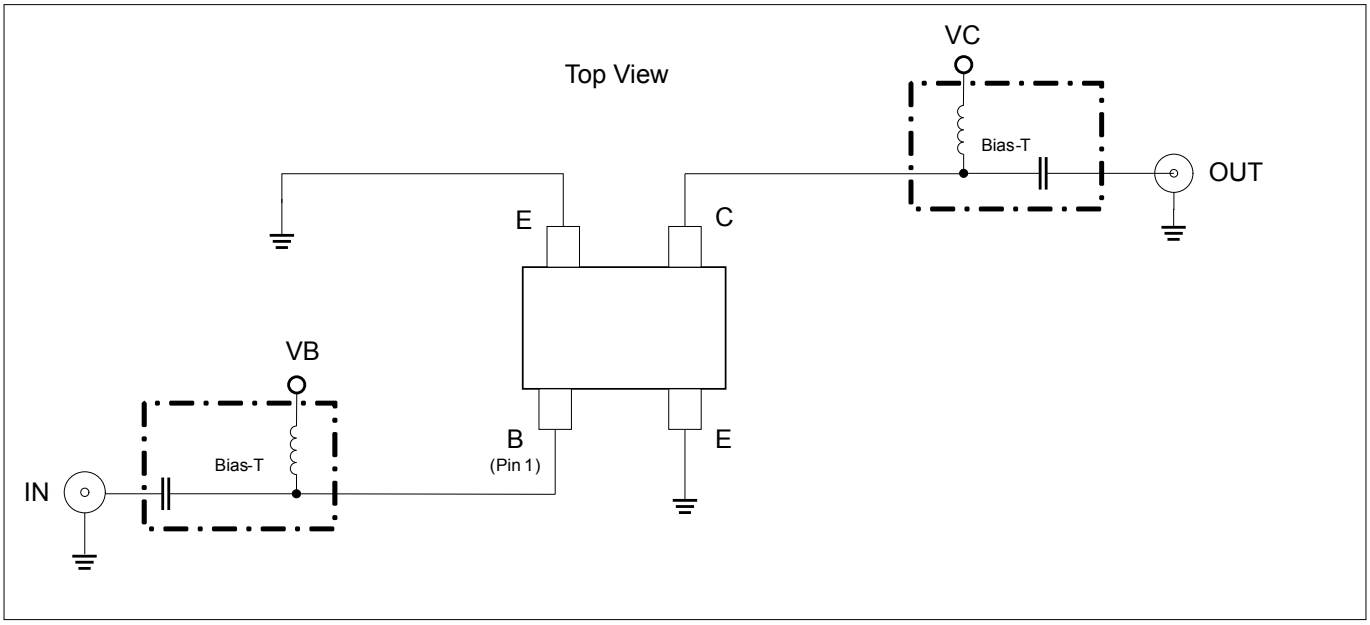

Figure 2 **Testing circuit**

Table 6 **AC characteristics, V_{CE} = 1.8 V, f = 0.45 GHz**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ms}		35			I_C = 10 mA
• Transducer gain	$\|S_{21}\|^2$		28			
Noise figure					dB	
• Minimum noise figure	NF_{min}		0.55			I_C = 5 mA
• Associated gain	G_{ass}		27			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		19.5			$Z_S = Z_L$ = 50 Ω, I_C = 10 mA
• 1 dB gain compression point at output	OP_{1dB}		4			

Table 7 **AC characteristics, V_{CE} = 1.8 V, f = 0.9 GHz**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ms}		31			I_C = 10 mA
• Transducer gain	$\|S_{21}\|^2$		27			
Noise figure					dB	
• Minimum noise figure	NF_{min}		0.6			I_C = 5 mA
• Associated gain	G_{ass}		26.5			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		19.5			$Z_S = Z_L$ = 50 Ω, I_C = 10 mA
• 1 dB gain compression point at output	OP_{1dB}		4			

Table 8 **AC characteristics, V_{CE} = 1.8 V, f = 1.5 GHz**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ms}		28.5			I_C = 10 mA
• Transducer gain	$\|S_{21}\|^2$		26			
Noise figure					dB	
• Minimum noise figure	NF_{min}		0.6			I_C = 5 mA
• Associated gain	G_{ass}		25			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		20			$Z_S = Z_L$ = 50 Ω, I_C = 10 mA
• 1 dB gain compression point at output	OP_{1dB}		4			

Table 9 **AC characteristics, V_{CE} = 1.8 V, f = 1.9 GHz**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ms}		27.5			I_C = 10 mA
• Transducer gain	$\|S_{21}\|^2$		25.5			
Noise figure					dB	
• Minimum noise figure	NF_{min}		0.65			I_C = 5 mA
• Associated gain	G_{ass}		24			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		21			$Z_S = Z_L$ = 50 Ω, I_C = 10 mA
• 1 dB gain compression point at output	OP_{1dB}		4.5			

Table 10 **AC characteristics, V_{CE} = 1.8 V, f = 2.4 GHz**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ms}		26.5			I_C = 10 mA
• Transducer gain	$\|S_{21}\|^2$		24			
Noise figure					dB	
• Minimum noise figure	NF_{min}		0.65			I_C = 5 mA
• Associated gain	G_{ass}		22.5			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		21			$Z_S = Z_L$ = 50 Ω, I_C = 10 mA
• 1 dB gain compression point at output	OP_{1dB}		4			

Table 11 **AC characteristics, V_{CE} = 1.8 V, f = 3.5 GHz**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ms}		25			I_C = 10 mA
• Transducer gain	$\|S_{21}\|^2$		22			
Noise figure					dB	
• Minimum noise figure	NF_{min}		0.7			I_C = 5 mA
• Associated gain	G_{ass}		20.5			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		22.5			$Z_S = Z_L$ = 50 Ω, I_C = 10 mA
• 1 dB gain compression point at output	OP_{1dB}		5			

Table 12 **AC characteristics, V_{CE} = 1.8 V, f = 5.5 GHz**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ms}		23			I_C = 10 mA
• Transducer gain	$\|S_{21}\|^2$		19			
Noise figure					dB	
• Minimum noise figure	NF_{min}		0.75			I_C = 5 mA
• Associated gain	G_{ass}		17.5			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		22			$Z_S = Z_L$ = 50 Ω, I_C = 10 mA
• 1 dB gain compression point at output	OP_{1dB}		5			

Table 13 **AC characteristics, V_{CE} = 1.8 V, f = 10 GHz**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ma}		16			I_C = 10 mA
• Transducer gain	$\|S_{21}\|^2$		13			
Noise figure					dB	
• Minimum noise figure	NF_{min}		1.1			I_C = 5 mA
• Associated gain	G_{ass}		13			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		19.5			$Z_S = Z_L$ = 50 Ω, I_C = 10 mA
• 1 dB gain compression point at output	OP_{1dB}		3			

Table 14 **AC characteristics, V_{CE} = 1.8 V, f = 12 GHz**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ma}		15.5			I_C = 10 mA
• Transducer gain	$\|S_{21}\|^2$		10.5			
Noise figure					dB	
• Minimum noise figure	NF_{min}		1.3			I_C = 5 mA
• Associated gain	G_{ass}		10.5			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		18.5			$Z_S = Z_L$ = 50 Ω, I_C = 10 mA
• 1 dB gain compression point at output	OP_{1dB}		1.5			

Note: *$G_{ms} = |S_{21} / S_{12}|$ for $k < 1$; $G_{ma} = |S_{21} / S_{12}| (k-(k^2-1)^{1/2})$ for $k > 1$. In order to get the NF_{min} values stated in this chapter, the test fixture losses have been subtracted from all measured results. OIP_3 value depends on termination of all intermodulation frequency components. Termination used for this measurement is 50 Ω from 0.2 MHz to 12 GHz.*

3.4 Characteristic DC diagrams

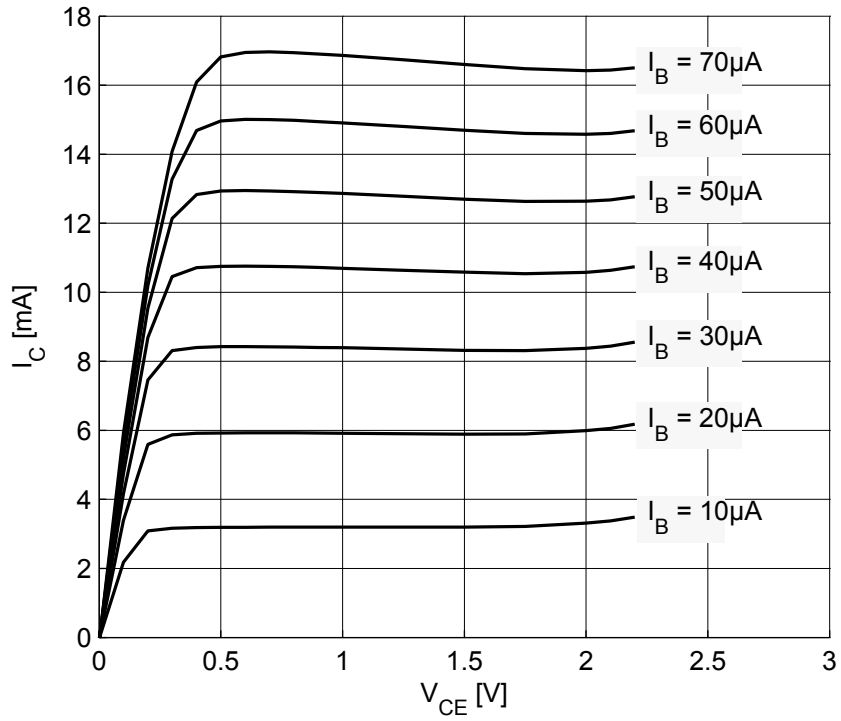

Figure 3 **Collector current vs. collector emitter voltage $I_C = f(V_{CE})$, I_B = parameter**

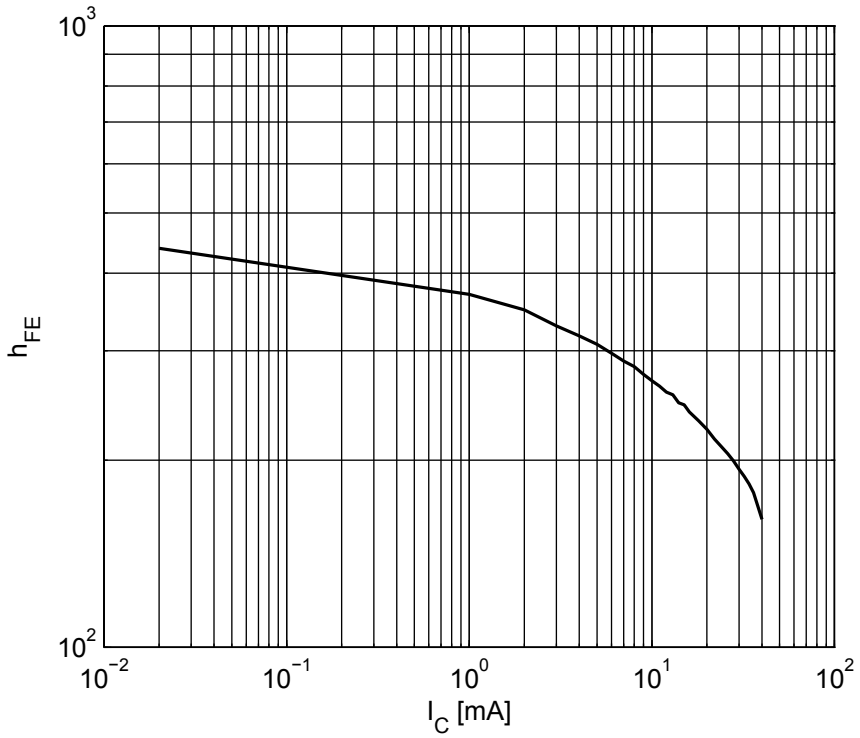

Figure 4 **DC current gain $h_{FE} = f(I_C)$, V_{CE} = 1.8 V**

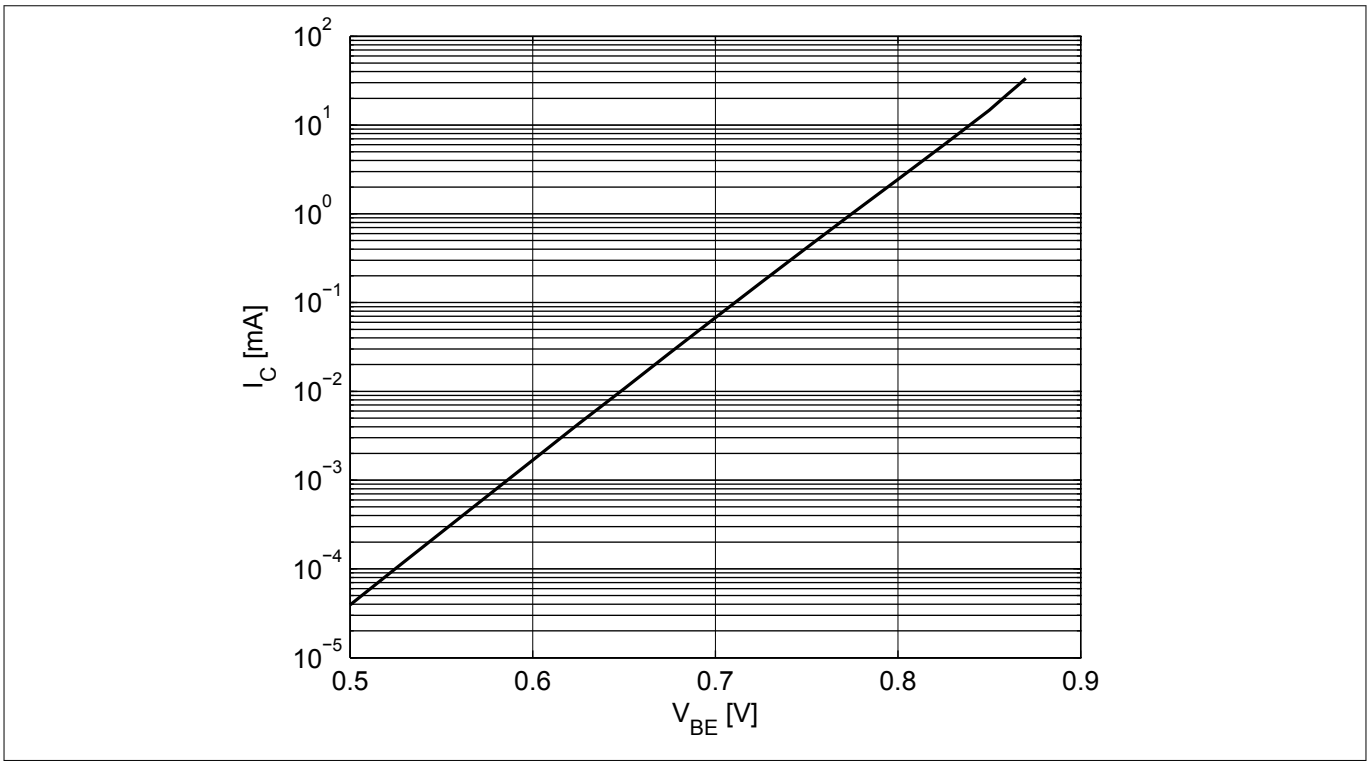

Figure 5 **Collector current vs. base emitter forward voltage $I_C = f(V_{BE})$, $V_{CE} = 1.8$ V**

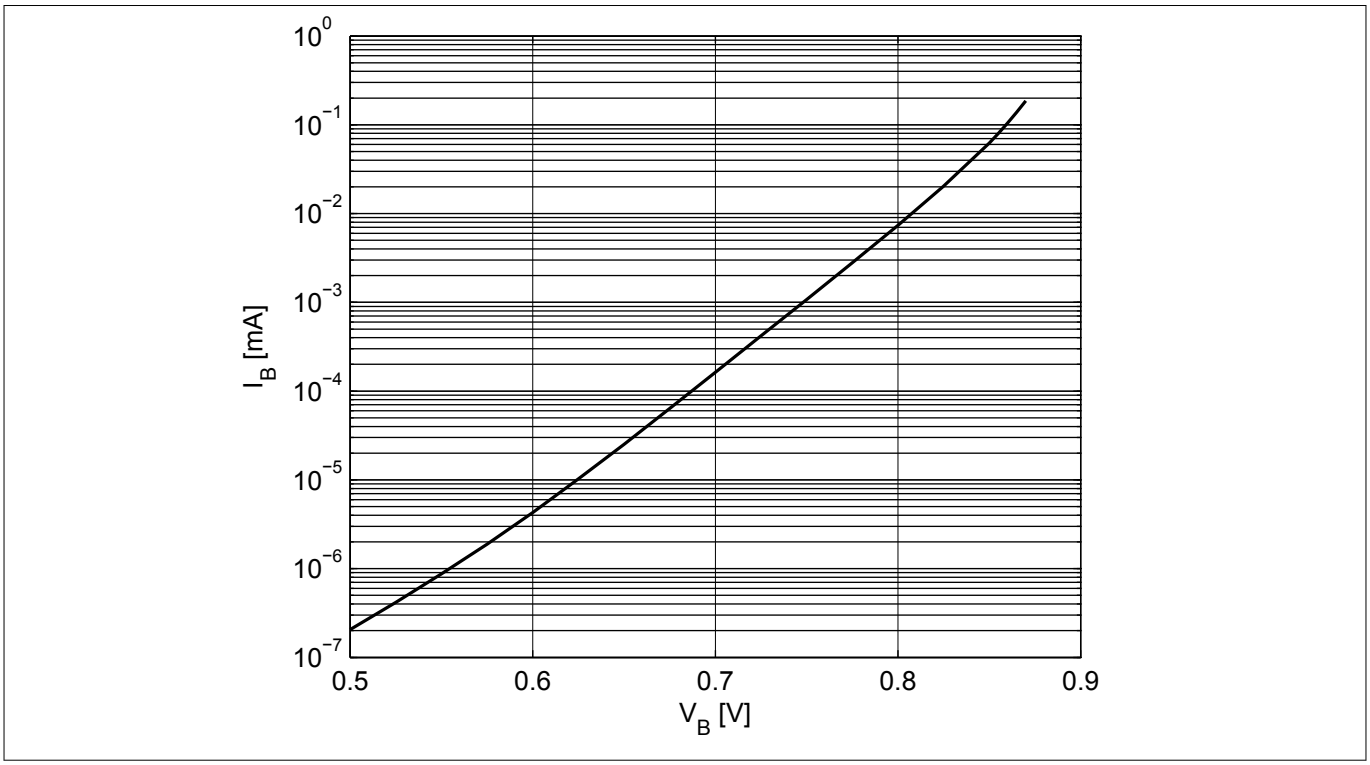

Figure 6 **Base current vs. base emitter forward voltage $I_B = f(V_{BE})$, $V_{CE} = 1.8$ V**

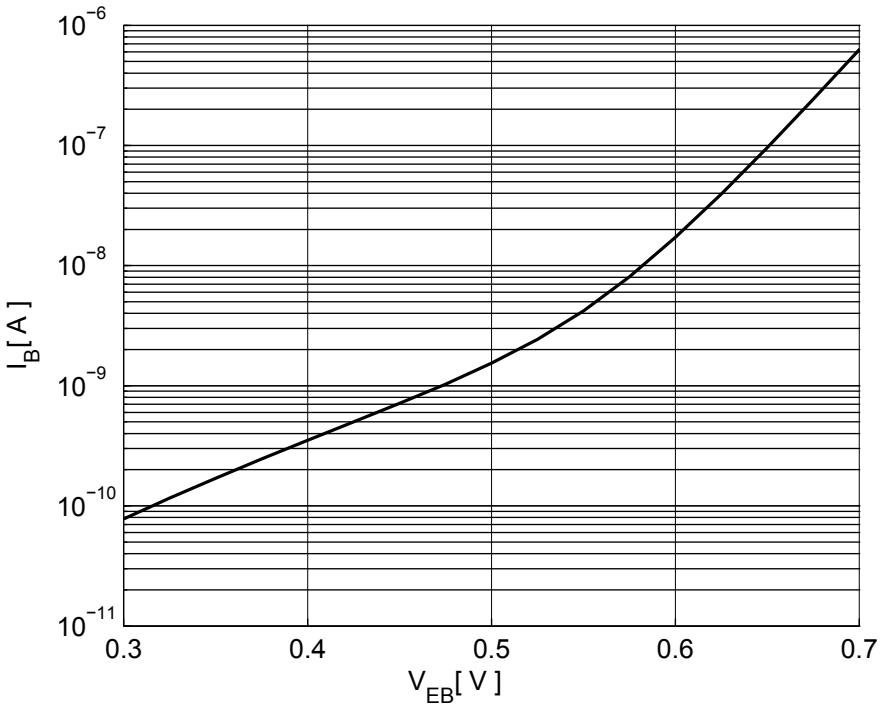

Figure 7 **Base current vs. base emitter reverse voltage $I_B = f(V_{EB})$, $V_{CE} = 1.8$ V**

3.5 Characteristic AC diagrams

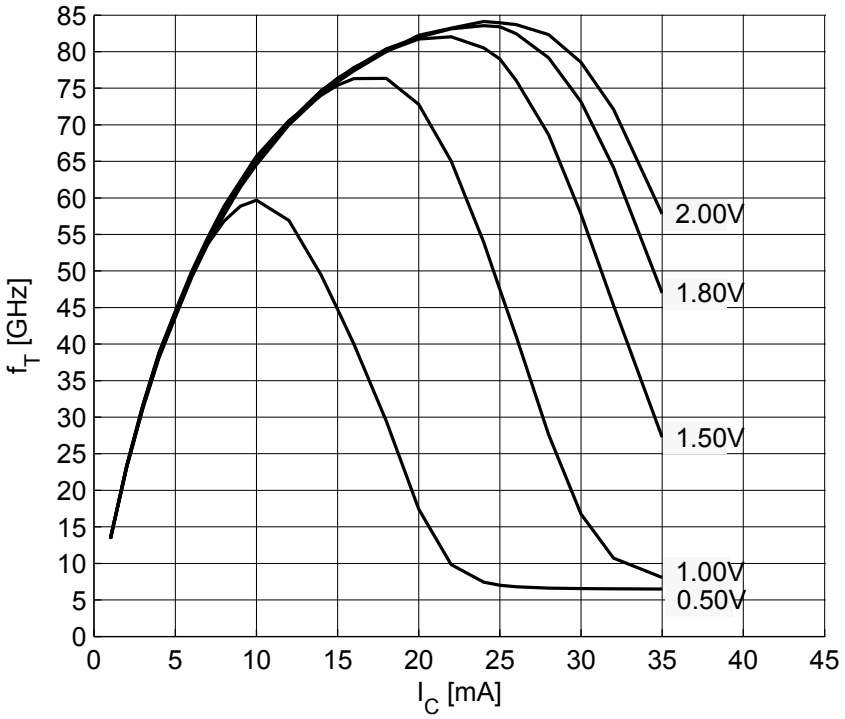

Figure 8 **Transition frequency $f_T = f(I_C)$, $f = 2$ GHz, V_{CE} = parameter**

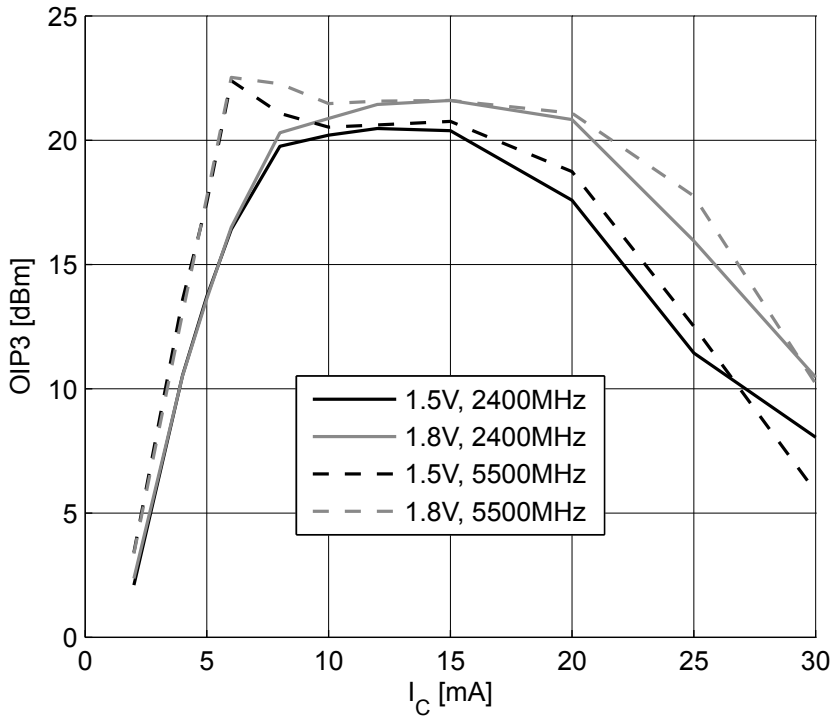

Figure 9 **3rd order intercept point at output $OIP_3 = f(I_C)$, $Z_S = Z_L = 50\ \Omega$, V_{CE}, f = parameter**

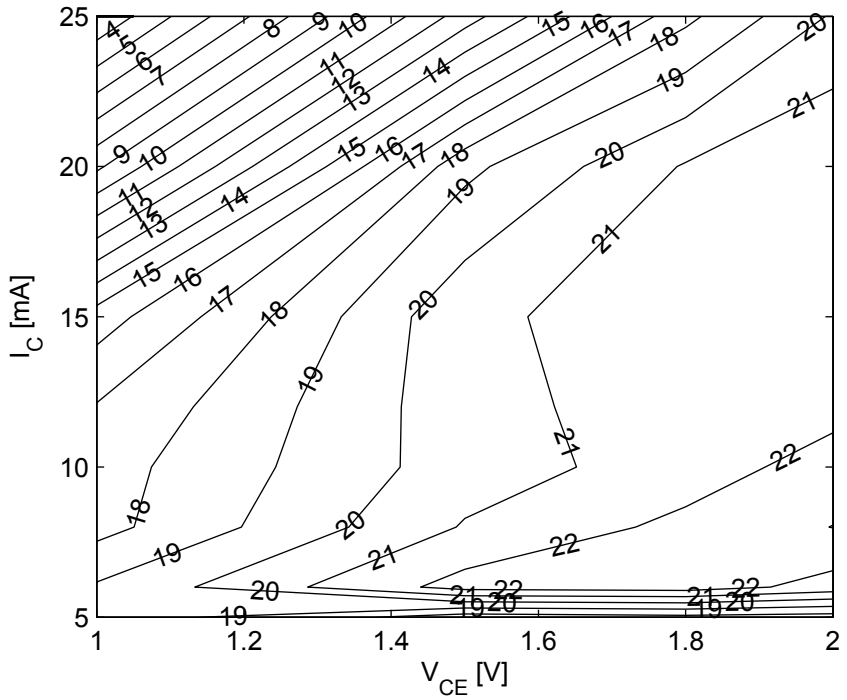

Figure 10 **3rd order intercept point at output OIP_3 [dBm] = f(I_C, V_{CE}), Z_S = Z_L= 50 Ω, f = 5.5 GHz**

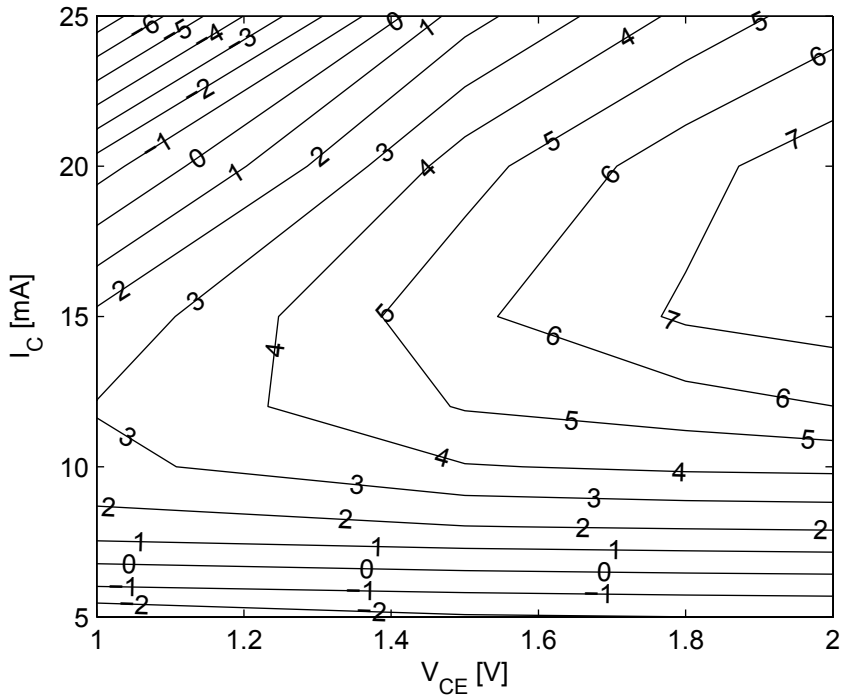

Figure 11 **Compression point at output OP_{1dB} [dBm] = f(I_C, V_{CE}), Z_S = Z_L= 50 Ω, f = 5.5 GHz**

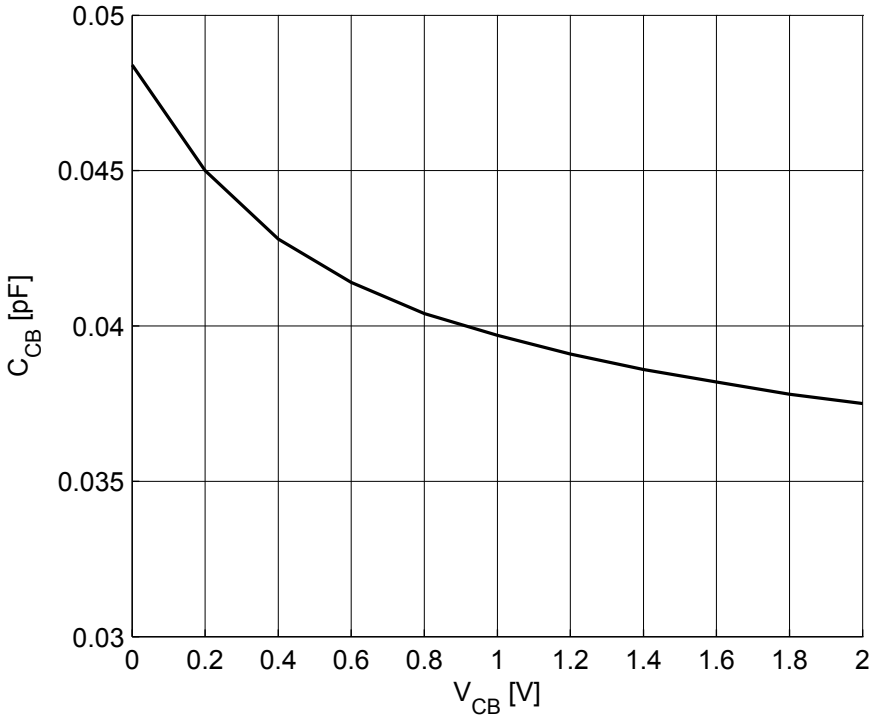

Figure 12 **Collector base capacitance C_{CB} = f(V_{CB}), f = 1 MHz**

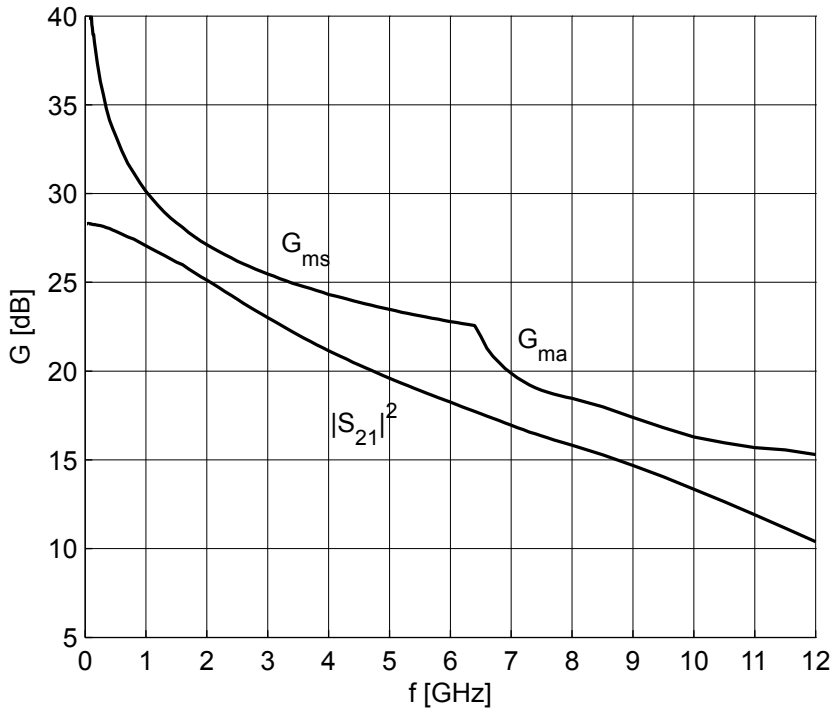

Figure 13 **Gain G_{ma}, G_{ms}, $|S_{21}|^2$ = f(f), V_{CE} = 1.8 V, I_C = 10 mA**

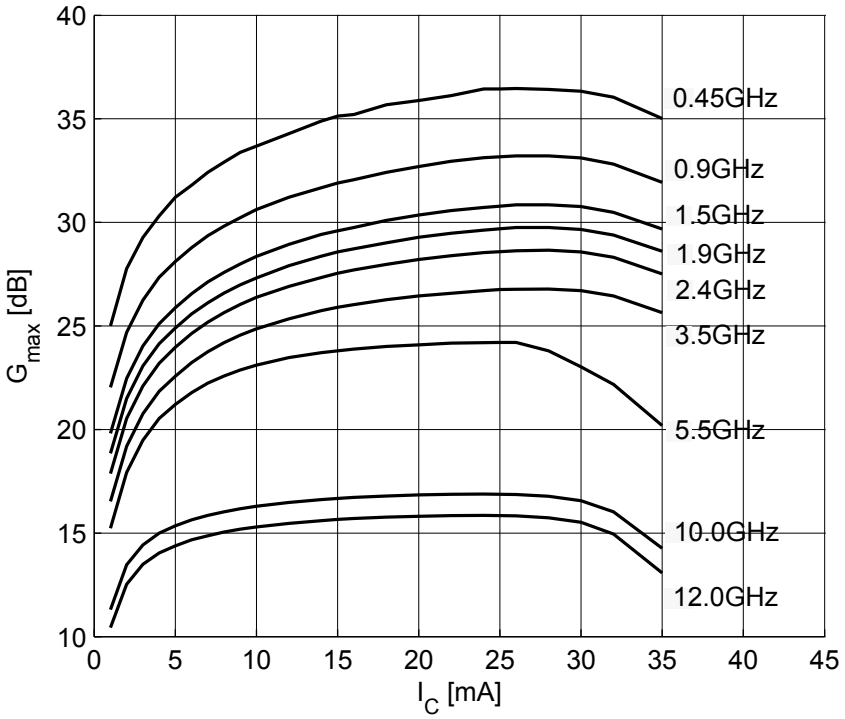

Figure 14 **Maximum power gain G_{max} = f(I_C), V_{CE} = 1.8 V, f = parameter in GHz**

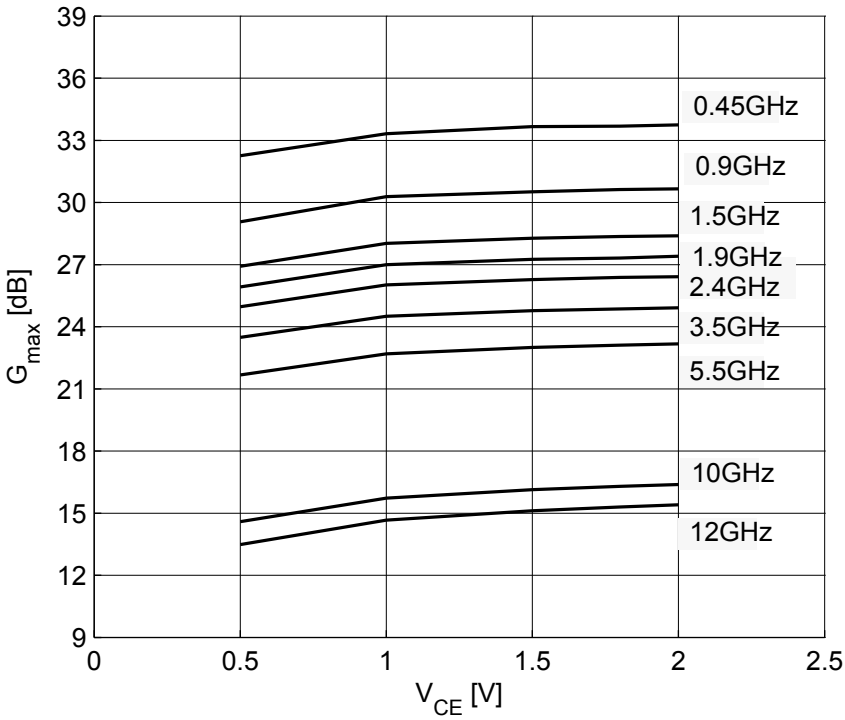

Figure 15 **Maximum power gain G_{max} = f(V_{CE}), I_C = 10 mA, f = parameter in GHz**

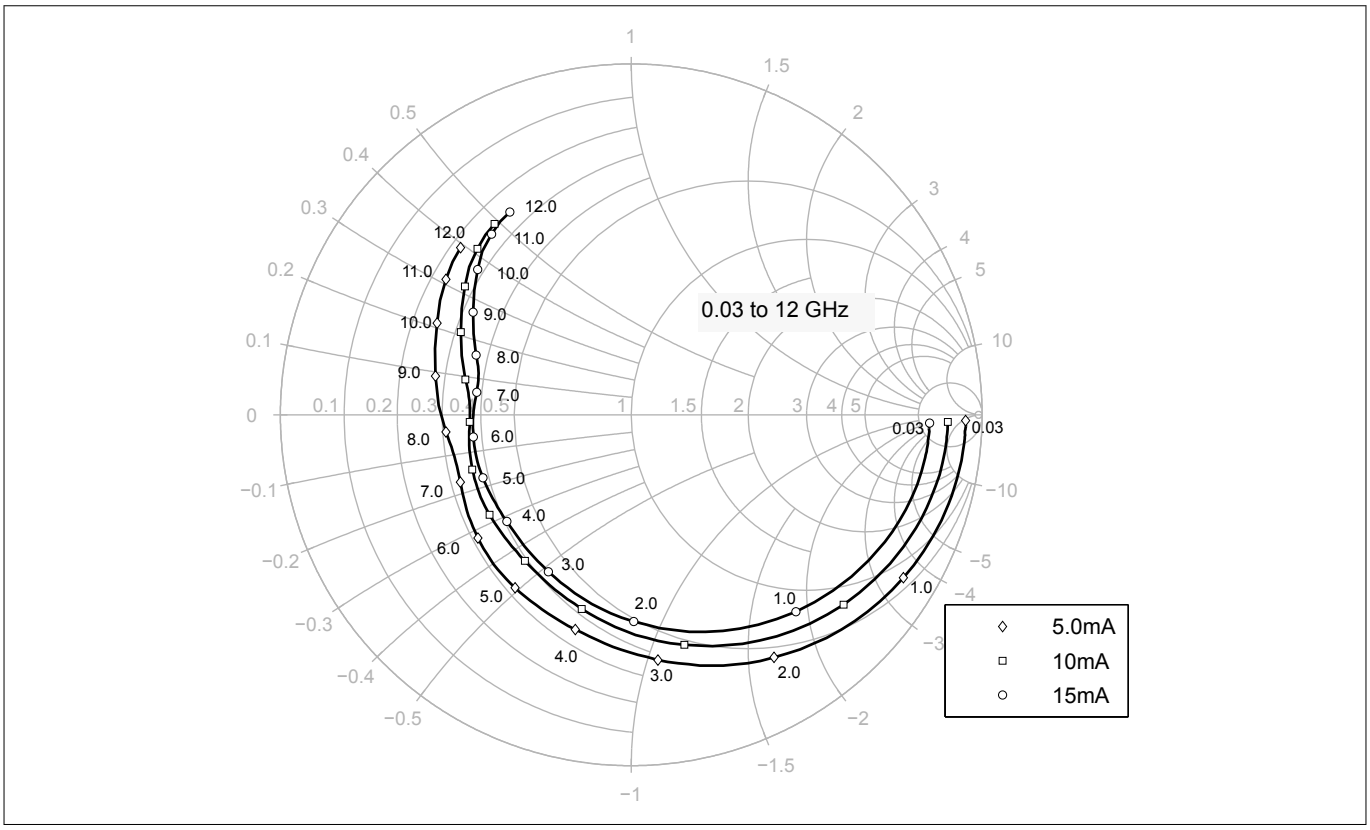

Figure 16 **Input reflection coefficient S_{11} = f(f), V_{CE} = 1.8 V, I_C = 5 / 10 / 15 mA**

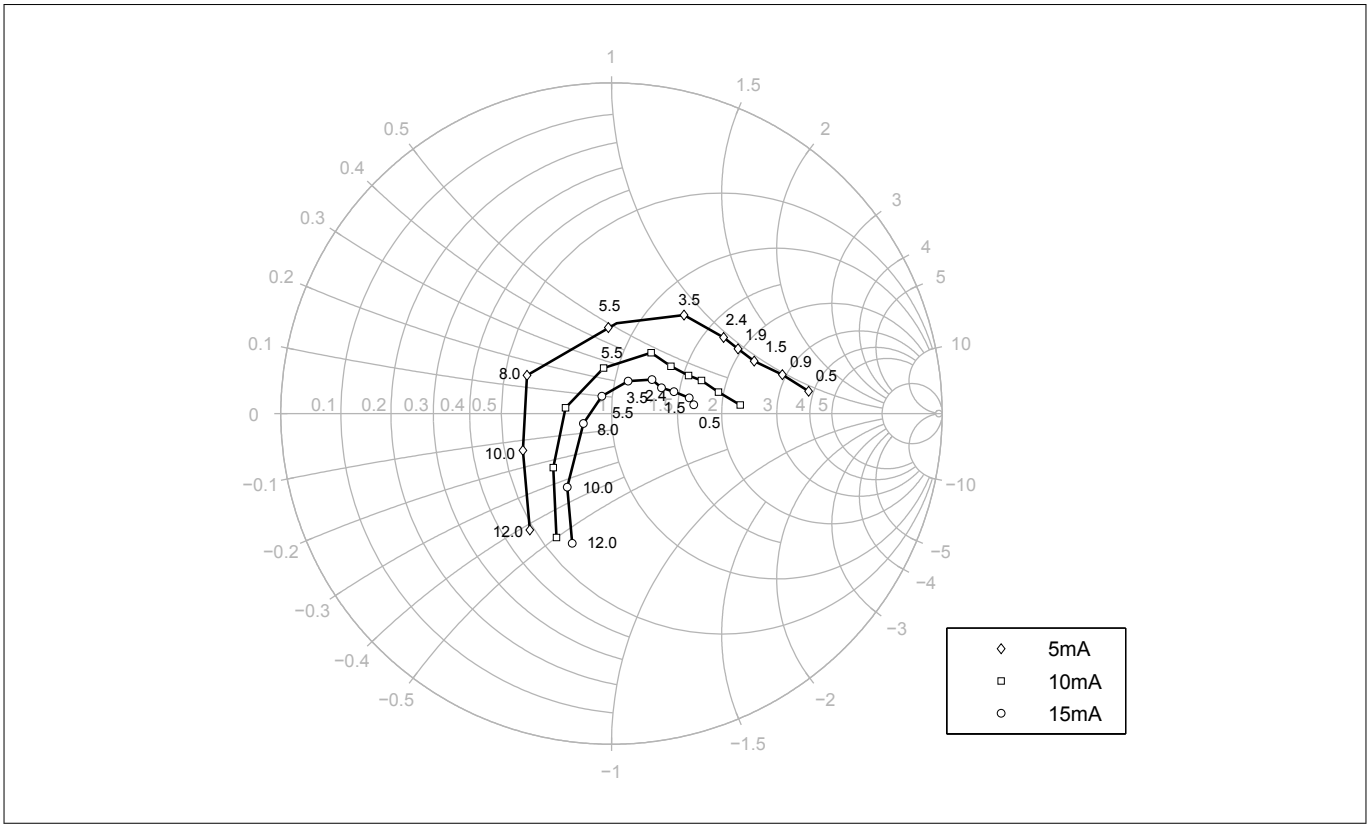

Figure 17 **Source impedance for minimum noise figure $Z_{S,opt}$ = f(f), V_{CE} = 1.8 V, I_C = 5 / 10 / 15 mA**

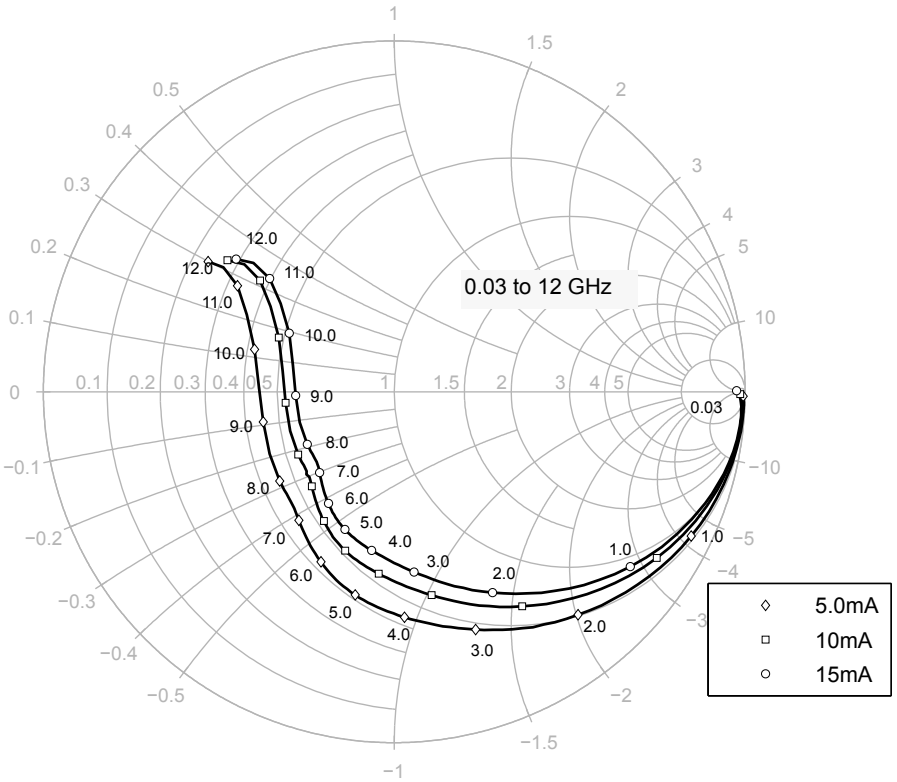

Figure 18 **Output reflection coefficient S_{22} = f(f), V_{CE} = 1.8 V, I_C = 5 / 10 / 15 mA**

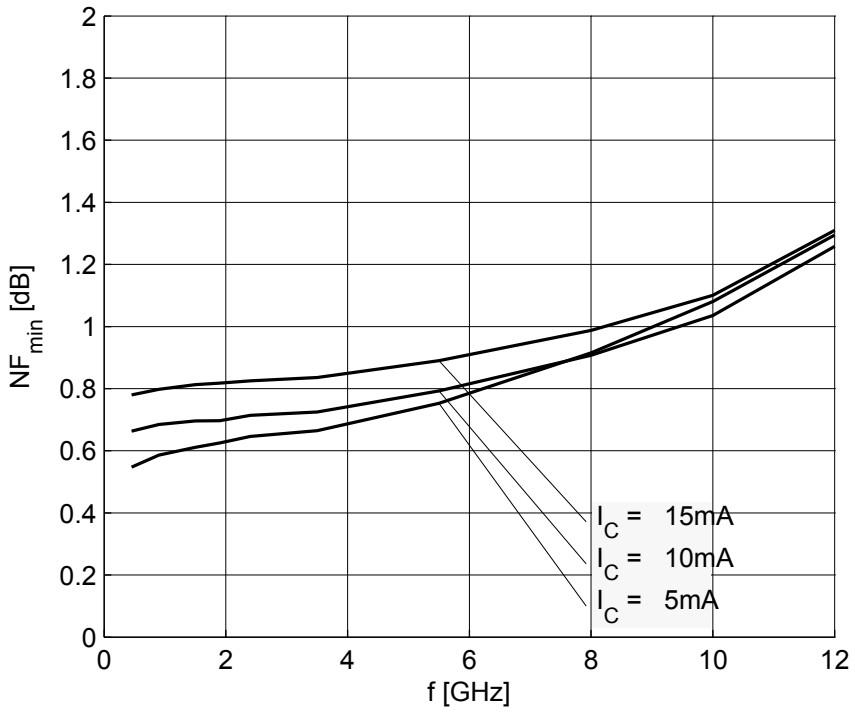

Figure 19 **Noise figure NF_{min} = f(f), V_{CE} = 1.8 V, Z_S = $Z_{S,opt}$, I_C = 5 / 10 / 15 mA**

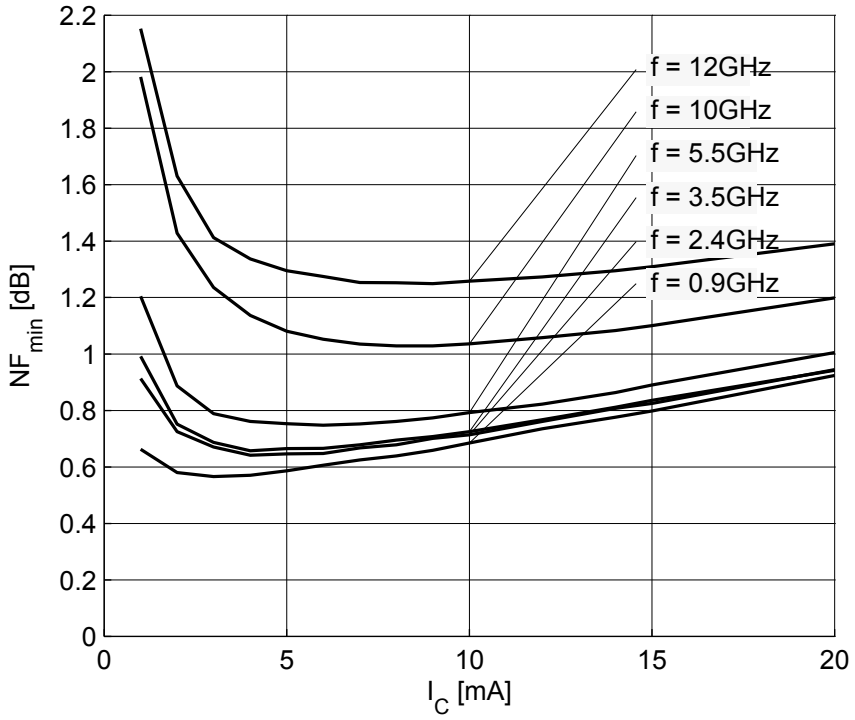

Figure 20 **Noise figure $NF_{min} = f(I_C)$, $V_{CE} = 1.8$ V, $Z_S = Z_{S,opt}$, f = parameter in GHz**

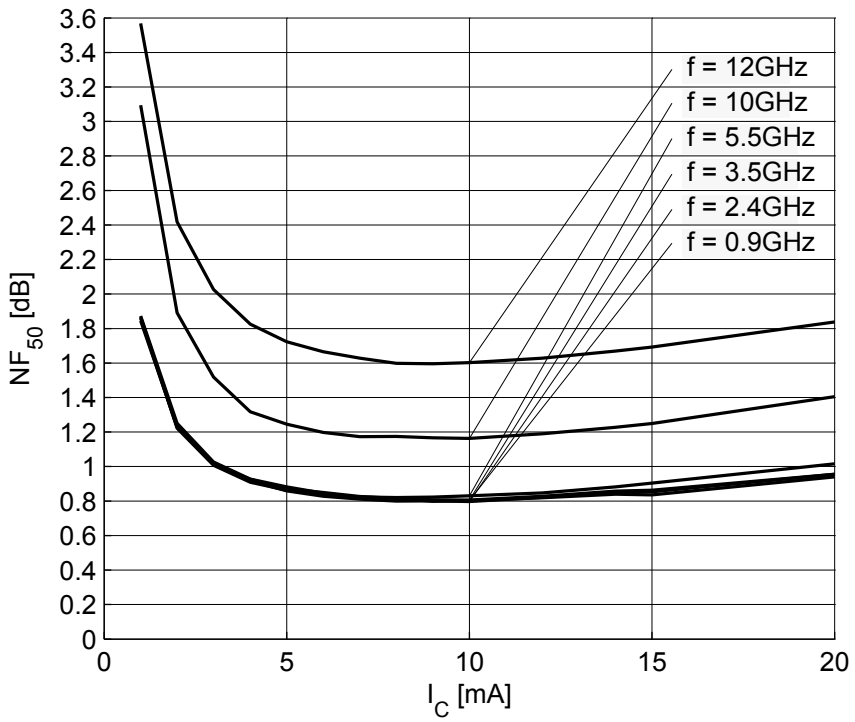

Figure 21 **Noise figure $NF_{50} = f(I_C)$, $V_{CE} = 1.8$ V, $Z_S = 50\ \Omega$, f = parameter in GHz**

Note: *The curves shown in this chapter have been generated using typical devices but shall not be considered as a guarantee that all devices have identical characteristic curves. $T_A = 25$ °C.*

4 Package information TSFP-4-1

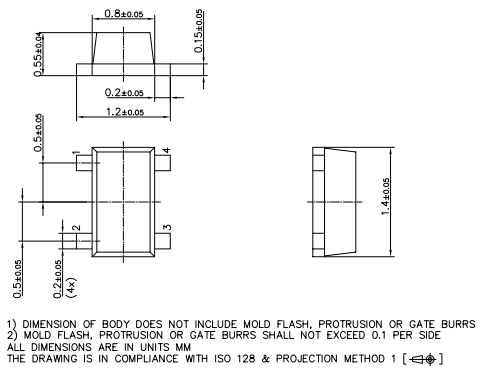

Figure 22 **Package outline**

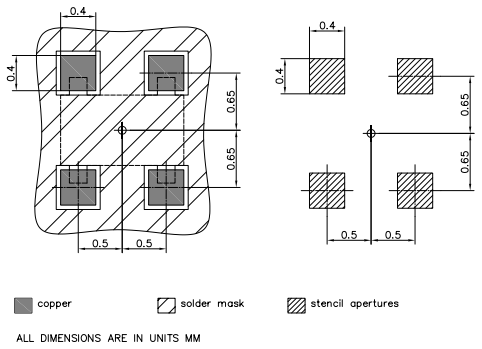

Figure 23 **Foot print**

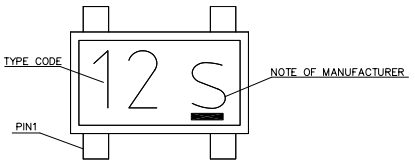

Figure 24 **Marking layout example**

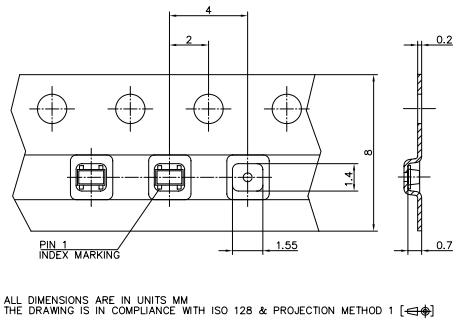

Figure 25 **Tape dimensions**

Revision history

Document version	Date of release	Description of changes
2.0	2018-09-26	New datasheet layout.

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